



12500 TI Boulevard, MS 8640, Dallas, Texas 75243

PCN Number:	20260803000.2	PCN Issued	August 05, 2026
Qualification of TI Melaka probe (TIEM-PR) as additional wafer Probe Test site for select devices		Sample request deadline:	N/A
		Estimated 1st ship date:	February 01, 2027

Change Type(s)	Test Site
ZVEI ID	SEM-TF-01

PCN Details

Description of Change:		
Texas Instruments is pleased to announce the qualification of TI Melaka probe (TIEM-PR) as additional wafer probe test site for the devices listed below.		
Group 1 device		
	Current	Additional
Wafer Probe Test site	FR-BIP-1 (FFAB)	TIEM-PR (TI Melaka Probe)
Group 2 device		
	Current	Additional
Wafer Probe Test site	CD-PR (CDAT)	TIEM-PR (TI Melaka Probe)
Test coverage, insertions, conditions will remain consistent with current testing		
Reason for Change:	Supply Continuity	

Anticipated impact on Form, Fit, Function, Quality or Reliability:	None								
Impact on Environmental Ratings	Checked boxes indicate the status of environmental ratings following implementation of this change. If below boxes are checked, there are no changes to the associated environmental ratings. <table><tr><td>RoHS</td><td>REACH</td><td>Green Status</td><td>IEC 62474</td></tr><tr><td>☒ No Change</td><td>☒ No Change</td><td>☒ No Change</td><td>☒ No Change</td></tr></table>	RoHS	REACH	Green Status	IEC 62474	☒ No Change	☒ No Change	☒ No Change	☒ No Change
RoHS	REACH	Green Status	IEC 62474						
☒ No Change	☒ No Change	☒ No Change	☒ No Change						
Changes to product identification resulting from this PCN:	None								

Group 1 Products Affected:		
OPA2320AQDGKRQ1	OPA2320AQDGKRTW	OPA2322AQDGKRQ1

Group 2 Products Affected:			
F280036CPMRQ1	F280038PMRQ1	INA229AQDGSRQ1	
F280036PMRQ1	F280039CPNQ1	INA237AQDGSRQ1	
F280037CPZRQ1	F280039CPZQ1	INA238AQDGSRQ1	
F280037PZRQ1	F280039CPZRQ1	INA239AQDGSRQ1	
F280038CPMQ1	F280039PZRQ1		
F280038CPMRQ1	INA228AQDGSRQ1		

For questions regarding this notice, e-mails can be sent to the Change Management team or your local Field Sales Representative.

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